

STS2DNF30L

Dual n-channel 30 V, 0.09 Ω, 3 A SO-8 STripFET™ Power MOSFET

Features

Туре	V _{DSS}	R _{DS(on)} max	I _D
STS2DNF30L	30V	<0.11Ω	3A

- Standard outline for easy automated surface mount assembly
- Low threshold gate drive

Application

■ Switching applications

Description

This Power MOSFET is the latest development of STMicroelectronics unique "single feature size" strip-based process. The resulting transistor shows extremely high packing density for low on-resistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

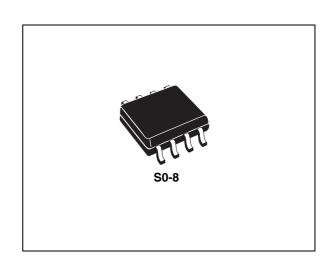


Figure 1. Internal schematic diagram

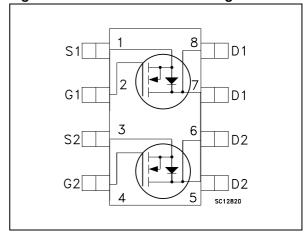


Table 1. Device summary

Order code	r code Marking Package		Packaging
STS2DNF30L	2DF30L	SO-8	Tape and reel

Contents STS2DNF30L

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STS2DNF30L Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{DS}	Drain-source voltage (v _{gs} = 0)	30	V
V _{GS}	Gate- source voltage	±18	V
I _D	Drain current (continuous) at T _C = 25°C	3	Α
I _D	Drain current (continuous) at T _C = 100°C	1.9	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	9	Α
P _{TOT}	Total dissipation at T _C = 25°C dual operation	1.6	W
' 101	Total dissipation at T _C = 25°C single operation	2	W
T _{stg}	Storage temperature	-55 to 150	°C
T _j	Max. operating junction temperature	150	°C

^{1.} Pulse width limited by safe operating area

Table 3. Thermal data

Symbol	Parameter	Value	Unit
D	Thermal resistance junction-ambient max single operation	62.5	°C/W
□thj-a	R _{thj-a} Thermal resistance junction-ambient max dual operation		C/VV
TJ	Maximum operating junction ambient	150	°C
T _{stg}	Storage temperature	-55 to 175	°C

Electrical characteristics STS2DNF30L

2 Electrical characteristics

(T_{CASE}=25°C unless otherwise specified)

Table 4. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source Breakdown voltage	$I_D = 250 \mu A, V_{GS} = 0$	30			V
I _{DSS}	Zero gate voltage Drain current (V _{GS} = 0)	V_{DS} = Max rating V_{DS} =Max rating, T_{C} =125°C			1 10	µА µА
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ±18V			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1	1.7	2.5	V
R _{DS(on)}	Static drain-source on resistance	$V_{GS} = 10V, I_D = 1A$ $V_{GS} = 5V, I_D = 1A$		0.09 0.13	0.11 0.15	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
g _{fs} ⁽¹⁾	Forward transconductance	$V_{DS}>I_{D(on)}xR_{DS(on)max}$ $I_{D}=2.5A$	-	2.5	-	S
C _{iss}	Input capacitance			121		pF
C _{oss}	Output capacitance	$V_{DS} = 25V, f = 1 \text{ MHz}, $ $V_{GS} = 0$	_	45	_	pF
C _{rss}	Reverse transfer capacitance	$V_{GS} = 0$		11		pF
Qg	Total gate charge		-	4.5	-	nC
Q_{gs}	Gate-source charge	$V_{DD} = 24V, I_D = 2A,$ $V_{GS} = 10V$	-	1.7	-	nC
Q_{gd}	Gate-drain charge	VGS = 10 V	-	0.9	-	nC

^{1.} Pulsed: Pulse duration = 300 μ s, duty cycle 1.5.

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time Rise time	V_{DD} =15 V, I_{D} =1A, R_{G} =4.7 Ω , V_{GS} =4.5V (see Figure 13)	-	19 20	-	ns ns
t _{d(off)}	Turn-off delay time Fall time	V_{DD} =15 V, I_{D} =1A, R_{G} =4.7 Ω , V_{GS} = 4.5V (see Figure 13)	-	12 8	-	ns ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max	Unit
I _{SD}	Source-drain current		-		3	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		12	Α
V _{SD} (2)	Forward on voltage	$I_{SD} = 2A, V_{GS} = 0$	ı		1.3	٧
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_{SD} = 2A, V_{DD} = 30V di/dt = 100A/ μ s, T_j = 150°C (see Figure 15)	1	19 8.1 0.85		ns nC A

^{1.} Pulse width limited by safe operating area.

^{2.} Pulsed: Pulse duration = 300 μ s, duty cycle 1.5%

Electrical characteristics STS2DNF30L

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance

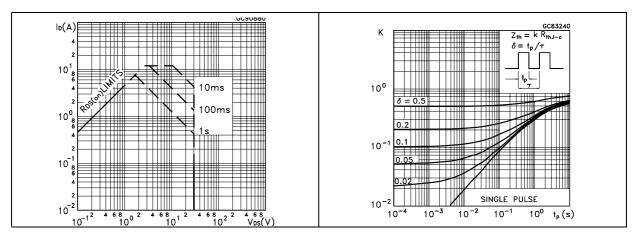


Figure 4. Output characteristics

Figure 5. Transfer characteristics

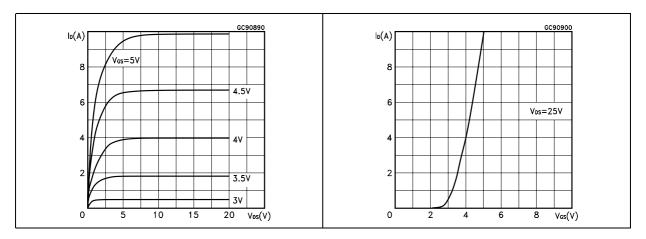
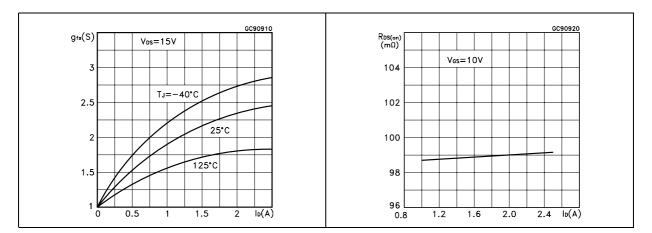


Figure 6. Transconductance

Figure 7. Static drain-source on resistance



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Figure 8. Gate charge vs. gate-source voltage Figure 9. Capacitance variations

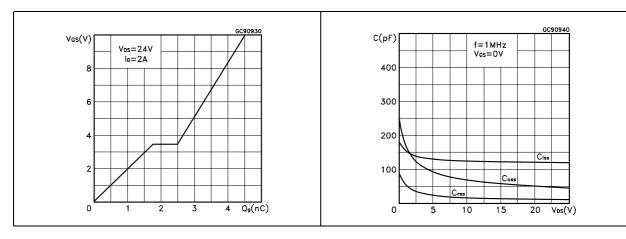


Figure 10. Normalized gate threshold voltage vs. temperature

Figure 11. Normalized on resistance vs. temperature

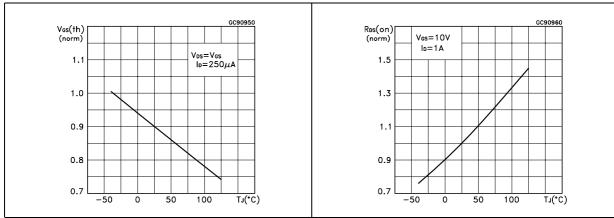
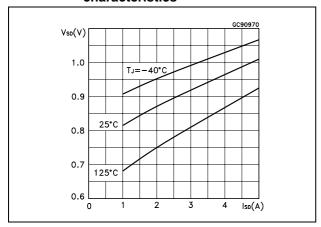


Figure 12. Source-drain diode forward characteristics



Test circuits STS2DNF30L

3 Test circuits

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

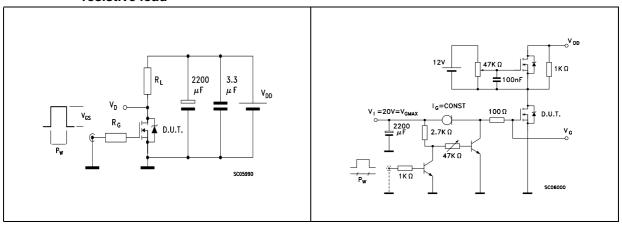


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped inductive load test circuit

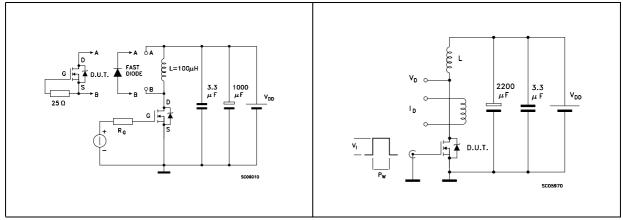
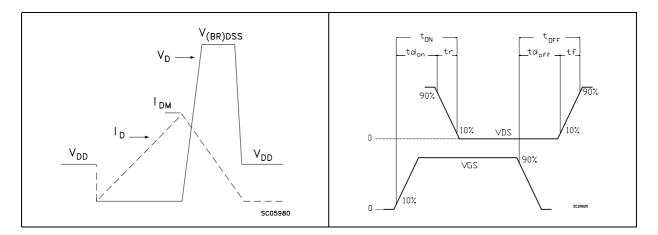


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform



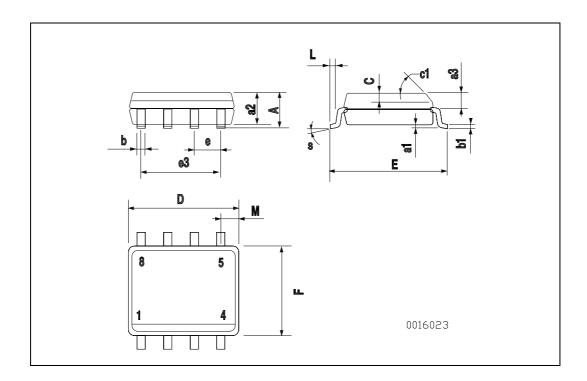
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4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

SO-8 MECHANICAL DATA

DIM.		mm.			inch	
DIWI.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			1.75			0.068
a1	0.1		0.25	0.003		0.009
a2			1.65			0.064
a3	0.65		0.85	0.025		0.033
b	0.35		0.48	0.013		0.018
b1	0.19		0.25	0.007		0.010
С	0.25		0.5	0.010		0.019
c1			45	(typ.)		
D	4.8		5.0	0.188		0.196
Е	5.8		6.2	0.228		0.244
е		1.27			0.050	
e3		3.81			0.150	
F	3.8		4.0	0.14		0.157
L	0.4		1.27	0.015		0.050
М			0.6			0.023
S			8 (r	nax.)		



STS2DNF30L Revision history

5 Revision history

Table 8. Document revision history

Date	Revision	Changes
21-Jun-2004	3	Complete document.
10-Nov-2006	4	The document has been reformatted.
31-Jan-2007	5	Typo mistake on <i>Table 2</i> .
03-May-2007	6	R _{DS(on)} Max value has been changed.
03-Nov-2009	7	Updated marking in <i>Table 1</i> .

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